

MICROSCOPE MODEL OF CURRENT CONTINUED

ON THE ROAD TO OHM'S LAW

o $\Sigma F = ma \rightarrow \Sigma F = m \frac{\Delta v}{\Delta t} \rightarrow \Delta v = \frac{\Sigma F \Delta t}{m} = \frac{e E \Delta t}{m}$

o AVERAGES...

$\Delta v \rightarrow \bar{v}_d = \frac{e E \bar{\Delta t}}{m}$ ← AVERAGE TIME BETWEEN COLLISIONS

COMBINE WITH MICRO MODEL OF CURRENT
 $I = enAv_d$

o RESULT...

$\frac{I}{A} = \frac{ne^2 \bar{\Delta t}}{m} E$

CURRENT DENSITY "J" CONDUCTIVITY "σ"
MATERIAL PROPERTY OF CONDUCTORS

ELECTRIC FIELD INSIDE CONDUCTOR

$J = \sigma E$ // ALMOST OHM'S LAW

FUNDAMENTAL DIMENSIONS "AMP"

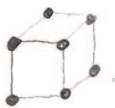
CONDUCTIVITY $\frac{[A]^2 [T]^3}{[M] [L]^3} \equiv \sigma = \frac{ne^2 \bar{\Delta t}}{m}$

o FOR A GIVEN CONDUCTOR $n = \text{CONSTANT}$

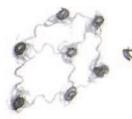
o HOW CAN WE AFFECT $\bar{\Delta t}$? ... TEMP AND IMPURITIES

* AS TEMP ↑, $\sigma \downarrow$ BECAUSE $\bar{\Delta t} \downarrow$ ← e^- COLLIDES MORE OFTEN

LOW TEMP

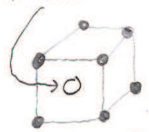


HIGH TEMP



LATTICE VIBRATES MORE, THUS $\bar{\Delta t} \downarrow$

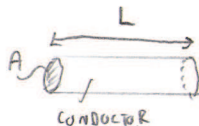
* IMPURITIES: IMPERFECTIONS IN LATTICE



CAN CAUSE $\bar{\Delta t} \downarrow$ THUS $\sigma \downarrow$

RESISTIVITY $\frac{[M] [L]^3}{[A]^2 [T]^3} \equiv \rho = \frac{1}{\sigma}$

RESISTANCE $\frac{[M] [L]^2}{[A]^2 [T]^3} \equiv R = \frac{\rho L}{A}$



FINALLY... OHM'S LAW

MICRO MODEL + ELECTRIC FIELD

$J = \sigma E$ + $|\vec{E}| = \frac{|\Delta V|}{L}$

$\frac{I}{A} = \frac{L}{RA} \frac{\Delta V}{L} \rightarrow I = \frac{\Delta V}{R}$ OR $\Delta V = IR$

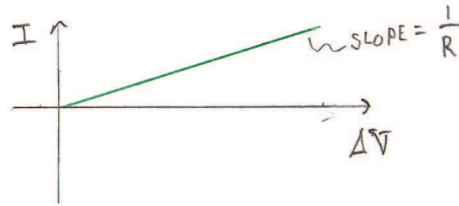
OHM'S LAW (APPLY A VOLTAGE DIFFERENCE ACROSS A WIRE WITH RESISTANCE AND CURRENT WILL FLOW)

* LIMITED APPLICATION: MOST MATERIALS

DO NOT OBEY OHM'S LAW (i.e. NON-OHMIC)

HOWEVER CERTAIN CIRCUIT ELEMENTS LIKE RESISTORS AND LIGHT BULBS CAN BE MODELLED WITH OHM'S LAW MOST OF THE TIME.

OHMIC MATERIALS (e.g.) RESISTOR



NON-OHMIC MATERIAL EXAMPLE ... SEMICONDUCTOR (TRANSISTOR)

